280387-1 🗸 ACTIVE

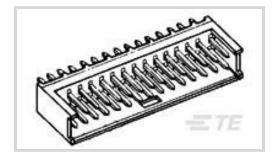
AMPMODU | AMPMODU Headers

TE Internal #: 280387-1 PCB Mount Header, Vertical, Board-to-Board, 30 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole -Solder, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **30**

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Partially Shrouded

Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Connector Contact Load Condition	Fully Loaded			
PCB Mount Orientation	Vertical			
Number of Positions	30			
Number of Rows	2			
Electrical Characteristics				
Dielectric Withstanding Voltage (Max)	750 V			
Body Features				
Connector Profile	Standard			
Primary Product Color	Black			
Contact Features				
PCB Contact Termination Area Plating Material Thickness	3.5 µm			
Contact Shape & Form	Round			

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Contact Mating Area Plating Material Finish	Bright			
PCB Contact Termination Area Plating Material	Tin			
Contact Base Material	Phosphor Bronze			
Contact Mating Area Plating Material	Tin			
Contact Type	Pin			
Termination Features				
Termination Post & Tail Length	3.5 mm[.138 in]			
Termination Method to Printed Circuit Board	Through Hole - Solder			
Mechanical Attachment				
Mating Retention	With			
Panel Mount Feature	Without			
Mating Alignment	With			
Mating Alignment Type	Polarization			
PCB Mount Retention	Without			
PCB Mount Alignment	Without			
Connector Mounting Type	Board Mount			

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]			
Housing Material	Thermoplastic			
Dimensions				
Row-to-Row Spacing	2.54 mm[.1 in]			
Usage Conditions				
Housing Temperature Rating	Standard			
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]			
Operation/Application				
Circuit Application	Power & Signal			
Packaging Features				
Packaging Quantity	250			

Product Compliance

For compliance documentation, visit the product page on TE.com>

PCB Mount Header, Vertical, Board-to-Board, 30 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

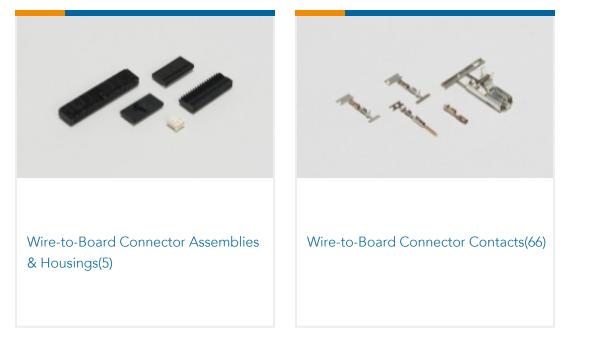


Also in the Series AMPMODU Headers

PCB Mount Header, Vertical, Board-to-Board, 30 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers







Customers Also Bought



TE Part #7-1676966-3 SMW2 100R 5%	TE Part #1734595-7 1.0 WTB SR VT HDR 7 POS	TE Part #3-1622824-1 RL73H 3A R12 1% 4K RL	TE Part #2199337-5 ASS'Y FOR MICRO SIM H1.18 8POS (EMBOSS)
		F.S.R.	
TE Part #2106091-3 4 pos Inverted Thru Board SMT Header	TE Part #292230-6 1.5 MINI CT SGL V SMT W/BOSS 6	TE Part #917728-1 2.5 SIGNAL D/LOCK HDR ASSY 8P	TE Part #292228-4 1.5 MINI CT SGL H SMT W/O BOSS



Documents

PCB Mount Header, Vertical, Board-to-Board, 30 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers



Product Drawings 2X15P AMPMODU II SHRD HDR, ST, TIN

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_280387-1_T_c-280387-1-t.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_280387-1_T_c-280387-1-t.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_280387-1_T_c-280387-1-t.3d_stp.zip

English

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Agency Approvals

UL

English